

NEW

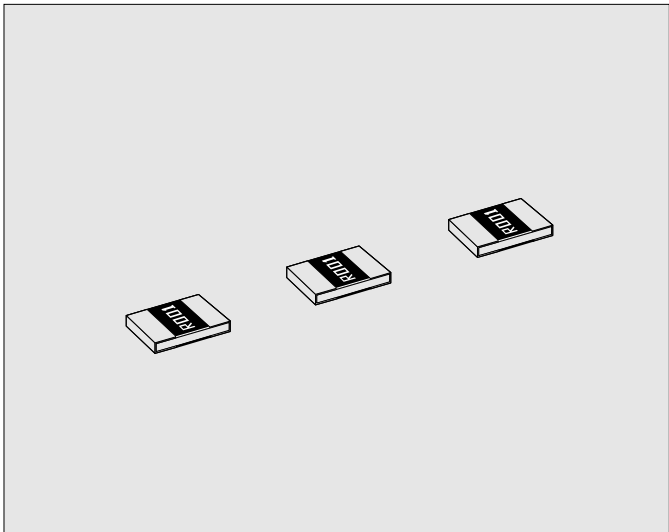
METAL-PLATE CHIP RESISTORS; LOW OHM

KAMAYA OHM

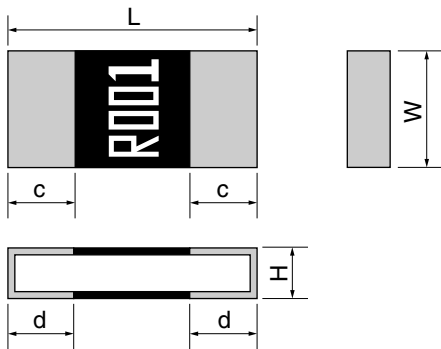
RLP,MLP

●Features

- 1. New Lineup, 1mΩ, 5mΩ, 10mΩ, 15mΩ.
- 2. Suitable for current sensing of Battery pack.
- 3. Stability Class: 5%



●Dimensions



Rated Resistnace marking is 4digit on over coating.

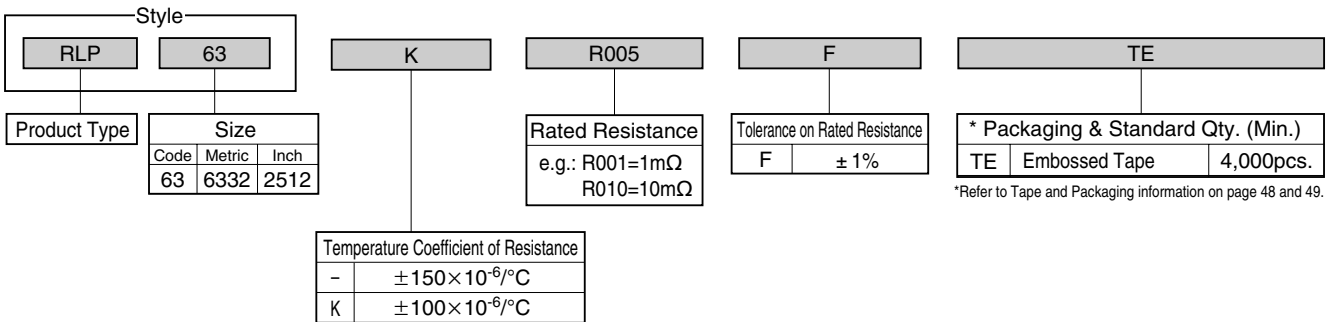
Unit : mm

Style	Metric	Inch	Rated Resistace	L	W	H	c	d	*Unit weight/pc.
RLP63	6332	2512	1mΩ	6.3 ± 0.25	3.2 ± 0.25	0.38 ± 0.15	2.2 ± 0.25	2.2 ± 0.25	50mg
			5mΩ		3.1 ± 0.25	0.34 ± 0.15	1.95 ± 0.25	1.95 ± 0.25	43mg
			10mΩ			0.23 ± 0.15	1.75 ± 0.25	1.75 ± 0.25	30mg
			15mΩ			0.23 ± 0.15	0.95 ± 0.25	0.95 ± 0.25	26mg
MLP63			5mΩ			0.51 ± 0.15	1.1 ± 0.25	1.1 ± 0.25	64mg

*Values for reference

●Part Number Description

Example



NEW METAL-PLATE CHIP RESISTORS; LOW OHM

RLP

●Ratings

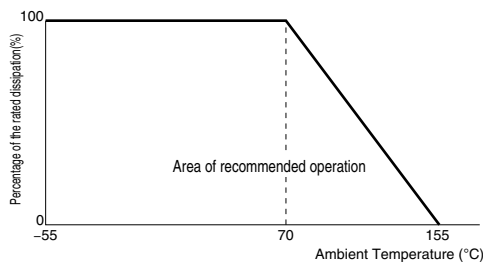
Style	Size Metric (Inch)	Rated Dissipation at 70°C W	Rated Current Range A	Combination of Rated Resistance Range and Temperature Coefficient of Resistance		Tolerance on Rated Resistance	Isolation Voltage V	Category Temperature Range °C
				Rated Resistance Range	Temperature Coefficient of Resistance 10 ⁻⁶ /°C			
RLP63	6332 (2512)	2.0	44.7	1m	± 150	F(± 1%)	100	-55~+155
		1.0	8.16,10,14.1	5m ,10m ,15m	± 100			
MLP63		2.0	20	5m				

Note1. Rated Current = $\sqrt{(\text{Rated Dissipation})/(\text{Rated Resistance})}$ Note2. Rated Voltage = $\sqrt{(\text{Rated Dissipation}) \times (\text{Rated Resistance})}$. (d.c. or a.c. r.m.s. Voltage)

Note3. Please contact Kamaya Sales Dept. for any other resistance values.

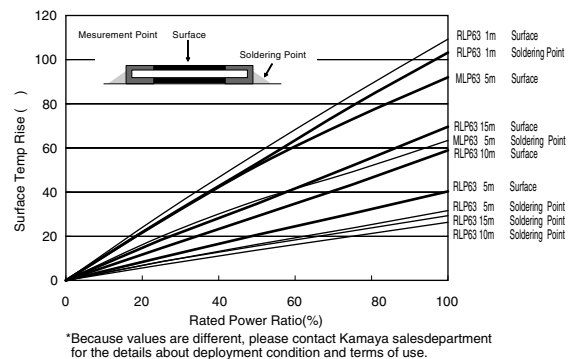
●Derating Curve

The derated values of dissipation for temperatures in excess of 70°C shall be indicated by the following Curve.

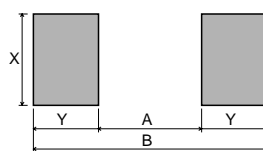
**●Climatic Category**

55/155/56

Lower Category Temperature -55°C
Upper Category Temperature +155°C
Duration of the Damp heat, Steady-State Test 56 days

●Surface Temperature Rise (Reference)**●Rated Resistance**

Style	Resistance	Code
RLP63	1m	R001
RLP63 · MLP63	5m	R005
RLP63	10m	R010
	15m	R015

●Recommended land Pattern

Style	Metric	Lnch	Rated Resistance	A	B	X	Y
RLP63	6332	2512	1m	2.0	7.6	3.5	2.8
			5m	2.4	7.6	3.5	2.6
			10m	4.0	7.6	3.5	1.8
			15m				
MLP63			5m				

*Values for reference

●Performance Characteristics JIS C 5201-1 : 1998

Description	Requirements	Test Methods
Voltage proof	No breakdown or flashover $R \geq 1G \text{ ohm}$	Clause 4.7 100Va.c., 60s
Variation of resistance with temperature	See Ratings Table	Clause 4.8 Measuring temperature : +20°C/+155°C/+20°C
Overload	$\Delta R \leq \pm 1\%$ No visible damage, legible marking	Clause 4.13 The applied voltage shall be 2.5 times of Rated Voltage, or equivalent current 2s.
Solderability	In accordance with Clause 4.17.4.5	Clause 4.17 235°C, 2s
Resistance to soldering heat	$\Delta R \leq \pm 1\%$	Clause 4.18 After immersion into the flux, the immersion into solder shall be carried out in Solder bath at 260°C for 5s.
Rapid change of temperature	$\Delta R \leq \pm 1\%$ No visible damage	Clause 4.19 5 cycles between -55°C and +155°C.
Climatic sequence	$\Delta R \leq \pm 5\%$ No visible damage	Clause 4.23 Dry/Damp heat(12+12h cycle), first cycle/ Cold/Damp heat(12+12h cycle), remaining cycle./ D.C.Load.
Damp test, steady state	$\Delta R \leq \pm 5\%$ No visible damage, legible marking	Clause 4.24 40°C, 95%R.H., 56 days, test a) of Clause 4.24.2.1
Endurance at 70°C	$\Delta R \leq \pm 5\%$ No visible damage	Clause 4.25.1 Rated current, 1.5h "ON", 0.5h "OFF", 70°C, 1,000h.
Endurance at the upper category temperature	$\Delta R \leq \pm 5\%$ No visible damage	Clause 4.25.3 155°C, no-load, 1,000h.
Adhesion	No visible damage	Clause 4.32 5N, 10s
Bend strength of the face plating	$\Delta R \leq \pm 1\%$	Clause 4.33 Amount of bend : 1 mm

●Precautions of use

Resistance value will be changed by soldering condition.

Please design products in consideration of this change of resistance value.